

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Seongjun KIM	10/21/2019
Jaekyung YANG	10/21/2019
Yongsoo LEE	10/21/2019
RECEIVING PARTY DATA	
Name:	LG ELECTRONICS INC.
Street Address:	128, YEQUI-DAERO, YEONGDEUNGPO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	07336
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16678795
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NAME OF SUBMITTER:	SHANNON STADNICK
SIGNATURE:	/Shannon Stadnick/
DATE SIGNED:	05/08/2020
Total Attachments: 4	
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source=Executed Assignment#page3.tif	

ASSIGNMENT

For valuable consideration, the receipt of which we acknowledge, and intending to be bound legally, we, SEONGJUN KIM, JAEKYUNG YANG, and YONGSOO LEE, each individually assigns to LG ELECTRONICS INC., a corporation formed under the laws of Republic of Korea, and having a principal place of business at 128, Yeoui-daero, Yeongdeungpo-gu, Seoul 07336, Republic of Korea, and its successors, transferees, and assignees (collectively the "Assignee"), all of our individual and joint right, title, and interest throughout the world in the invention(s) (the "Subject Matter") described in a patent application that names us as inventors, is titled "INDUCTION HEATING DEVICE HAVING IMPROVED INSULATION STRUCTURE." and was or will be filed in the United States Patent and Trademark Office on November 08, 2019, as application 16/678,795 (the "Application"). We authorize the insertion of the filing date and application number above.

This Assignment assigns, in addition to the Subject Matter of the Application, (a) the Application and all other applications that may be made for, and all patents, utility models, design registrations, and other rights of exclusion and inventors' certificates for, any of the Subject Matter (collectively the "Applications and Granted Rights") in every country or region and under every treaty or convention, (b) the right to claim priority based on and the benefit of the filing date of any of the Applications and Granted Rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other applicable treaties or conventions, and (c) the right to pursue, collect, and retain in the Assignee's name or otherwise, damages and any other remedies arising from any past, present, or future infringement of the Subject Matter, the Applications and Granted Rights, and any other rights assigned by this Assignment.

We authorize the Assignee to apply for and pursue protection for any or all of the Subject Matter, the Applications and Granted Rights, and any other rights assigned by this Assignment in all countries, regions, and territories of the world, in our names or in the Assignee's name.

We represent and warrant that we have the right and power to make this Assignment and that we have not made and will not make any other assignment that conflicts with this Assignment.

We will communicate to the Assignee (or, at the request of the Assignee to other parties) all known facts in any form relating to the Subject Matter; will execute and provide all oaths and declarations, statements, testimony, assignments, powers of attorney, applications, and documents; and will perform all other lawful acts necessary or desirable to secure fully to the Assignee the rights, titles, and interests assigned by this Assignment.

SK
Seongjun KIM

Date: 10/21/19

Witnessed by:

Signature: SK

Date: October 31, 2019

Print Name: Jieun JANG

Signature: SK

Date: October 31, 2019

Print Name: Hyojin KIM

JK YANG
Jaekyung YANG

Date: October 21, 2019

Witnessed by:

Signature: JANG

Date: October 31, 2019

Print Name: Jieun JANG

Signature: 김호진

Date: October 31, 2019

Print Name: Hyojin KIM

Lee Yongsoo
Yongsob LEE

Date: October 21, 2019

Witnessed by:

Signature: JANG

Date: October 31, 2019

Print Name: Jieun JANG

Signature: Hyojin

Date: October 31, 2019

Print Name: Hyojin KIM

The Assignee hereby acknowledges and accepts the foregoing assignment.

Assignee: LG ELECTRONICS INC.

Signature: _____ Date: _____

Name: _____

Title: _____

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